PTSM 0,5/ 3-HH0-2,5-SMD R32 - PCB header

1808200

https://www.phoenixcontact.com/us/products/1808200

Please be informed that the data shown in this PDF document is generated from our online catalog. Please find the complete data in the user documentation. Our general terms of use for downloads are valid.





PCB headers, nominal cross section: 0.5 mm^2, color: black, nominal current: 6 A, rated voltage (III/2): 160 V, contact surface: Sn, contact connection type: Pin, number of potentials: 3, number of rows: 1, number of positions: 3, number of connections: 3, product range: PTSM 0,5/..-HH-SMD, pitch: 2.5 mm, mounting: SMD soldering, pin layout: Linear pad geometry, number of solder pins per potential: 1, plug-in system: COMBICON PTSM, Pin connector pattern alignment: Standard, locking: without, mounting method: without, type of packaging: 32 mm wide tape

Your advantages

- Designed for integration into the SMT soldering process
- Supplied in tape-on-reel packing according to IEC 60286-3 for automated mounting
- Additional solder anchors reduce the mechanical strain on the soldering spots

Commercial data

Item number	1808200
Packing unit	600 pc
Minimum order quantity	600 pc
Sales key	AA01
Product key	AAAUPB
GTIN	4046356694469
Weight per piece (including packing)	1.35 g
Weight per piece (excluding packing)	1.326 g
Customs tariff number	85366930
Country of origin	IN

Technical data

Product properties

Product type	PCB headers
Product family	PTSM 0,5/..-HH-SMD
Product line	COMBICON Connectors XS
Type	Standard
Number of positions	3
Pitch	2.5 mm
Number of connections	3
Number of rows	1
Number of potentials	3
Mounting type	without
Pin layout	Linear pad geometry
Solder pins per potential	1

Fitting of components

Partial assembly	No

Electrical properties

Properties

Nominal current I_N	6 A
Nominal voltage U_N	160 V
Contact resistance	3.6 mΩ
Rated voltage (III/3)	50 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	160 V
Rated surge voltage (II/2)	2.5 kV

Mounting

Mounting type	SMD soldering
Pin layout	Linear pad geometry

Processing notes

Process	Reflow soldering
Moisture Sensitive Level	MSL 1
Classification temperature T_c	260 °C
Solder cycles in the reflow	3

Material specifications

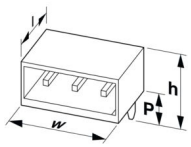
Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 µm - 5 µm Sn)
Metal surface contact area (middle layer)	Nickel (1.3 µm - 3 µm Ni)
Metal surface soldering area (top layer)	Tin (3 µm - 5 µm Sn)
Metal surface soldering area (middle layer)	Nickel (1.3 µm - 3 µm Ni)

Material data - housing

Color (Housing)	black (9005)
Insulating material	LCP
Insulating material group	IIIa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Dimensions

Dimensional drawing	
Pitch	2.5 mm
Width [w]	13.1 mm
Height [h]	5 mm
Length [l]	9.5 mm

PCB design

Pad geometry	1.2 x 3.2 mm

Mechanical tests

Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

Polarization and coding

Specification	IEC 60512-13-5:2006-02
Result	Test passed

Contact holder in insert

Specification	IEC 60512-15-1:2008-05
Contact holder in insert Requirements >20 N	Test passed

Insertion and withdrawal forces

Specification	IEC 60512-13-2:2006-02
Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	4 N
Withdraw strength per pos. approx.	4 N

Electrical tests

Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	8

Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	IIIa
Comparative tracking index (IEC 60112)	CTI 175
Rated insulation voltage (III/3)	50 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	1.9 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.6 mm
Rated insulation voltage (II/2)	160 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	1.6 mm

Environmental and real-life conditions

Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	1.75 kV
Contact resistance R_1	3.6 mΩ
Contact resistance R_2	3.8 mΩ

Insertion/withdrawal cycles	25
Insulation resistance, neighboring positions	> 5 MΩ

Climatic test

Specification	ISO 6988:1985-02
Corrosive stress	0.2 dm^3 SO_2 on 300 dm^3/40 °C/1 cycle
Thermal stress	100 °C/168 h
Power-frequency withstand voltage	0.84 kV

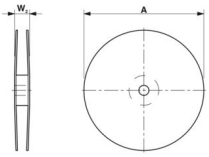
Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

Ambient conditions

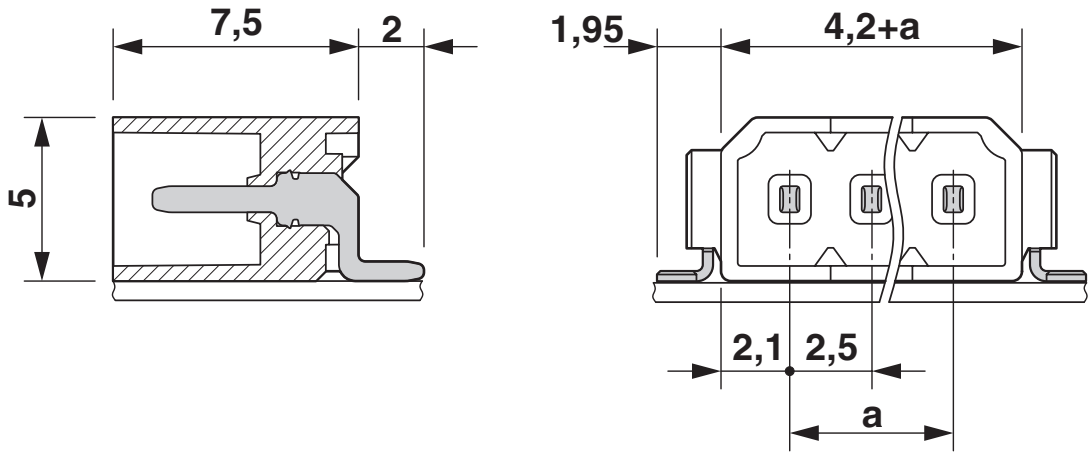
Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

Packaging specifications

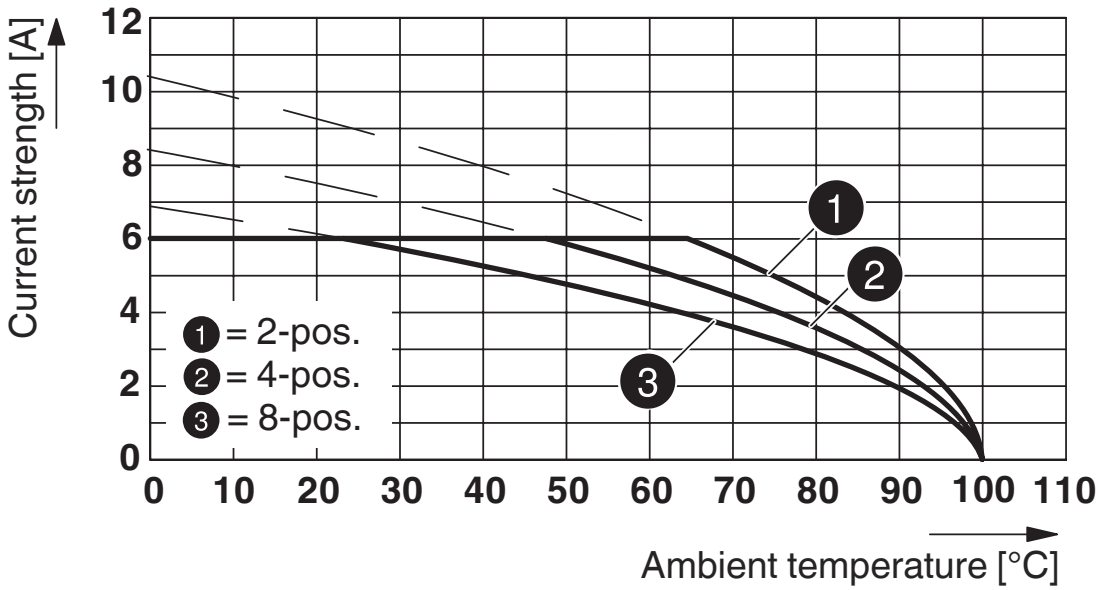
Dimensional drawing	
Type of packaging	32 mm wide tape
[W] tape width	32 mm
[W2] coil overall dimension	≤ 38.4 mm
[A] coil diameter	≤ 330 mm
Outer packaging type	Transparent-Bag

Drawings

Dimensional drawing

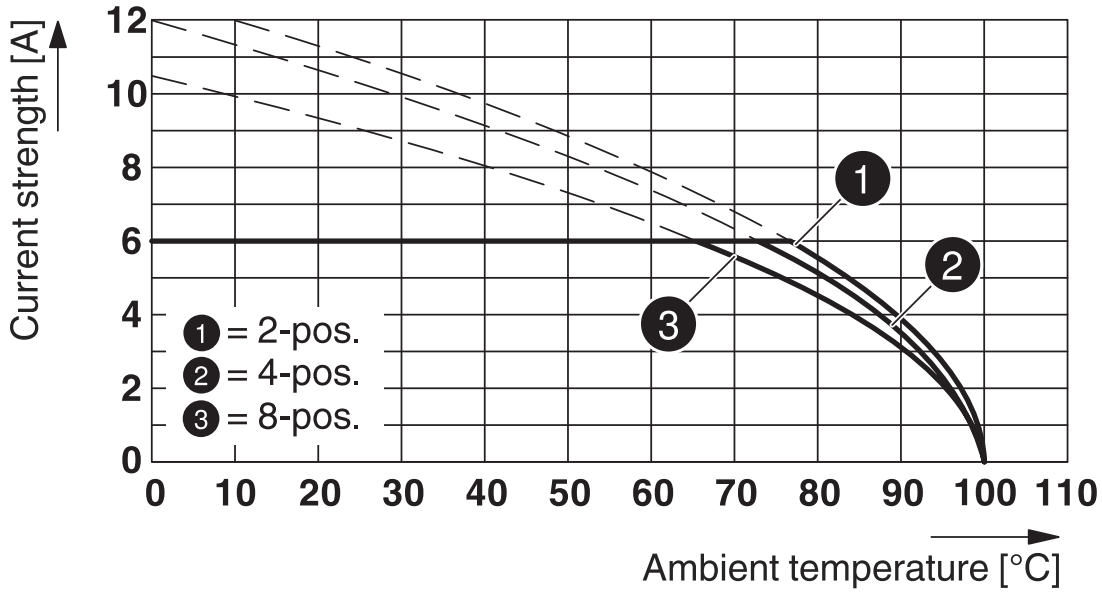


Diagram



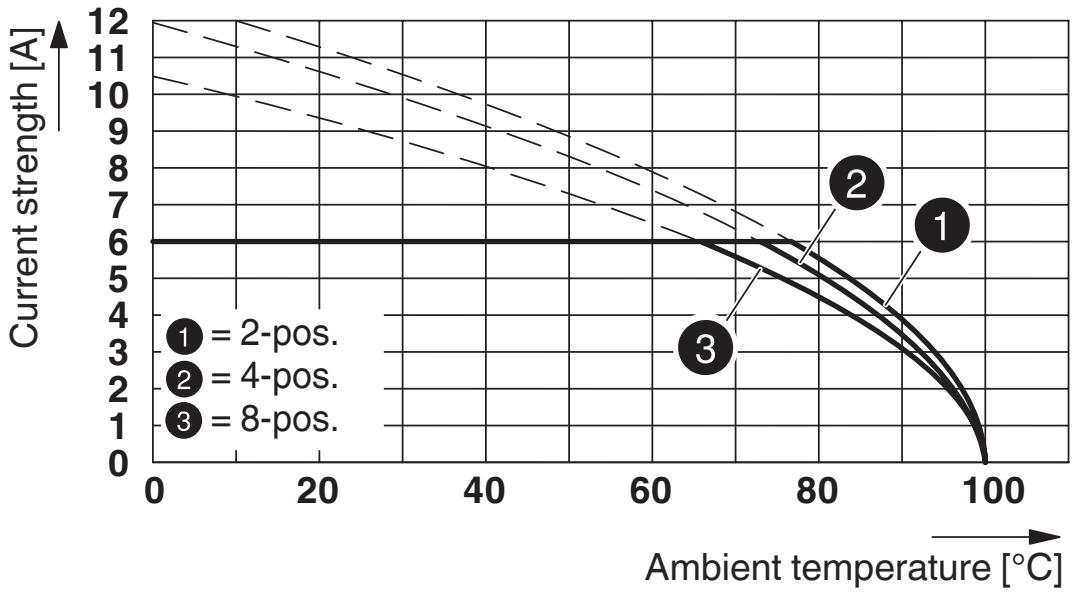
Type: PTSM 0,5/...-HHI-2,5-SMD R... with PTSM 0,5/...-HH-2,5-SMD R...

Diagram



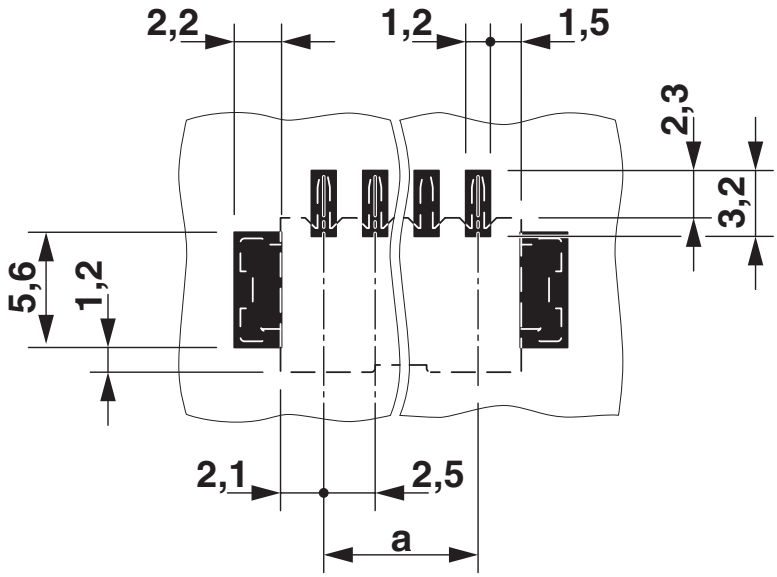
Type: PTSM 0,5/...-PL-2,5 ... with PTSM 0,5/...-HH-2,5-SMD... R...

Diagram



Derating curve for: PTSM 0,5/..-P-2,5 with PTSM 0,5/..-HH-2,5-SMD R..

Drilling plan/solder pad geometry



Approvals

To download certificates, visit the product detail page: https://www.phoenixcontact.com/us/products/1808200

UL Recognized
Approval ID: E118976-20130619

	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
B				
	150 V	5 A	-	-

cULus Recognized
Approval ID: E60425-20110108

	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
B				
	150 V	6 A	-	-

VDE Zeichengenehmigung
Approval ID: 40048497

	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
keine				
	160 V	6 A	-	-

Classifications

ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

ETIM

ETIM 10.0	EC002637

UNSPSC

UNSPSC 21.0	39121400

Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions

China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%

Phoenix Contact 2026 © - all rights reserved
https://www.phoenixcontact.com

Phoenix Contact USA
586 Fulling Mill Road
Middletown, PA 17057, United States
(+717) 944-1300
info@phoenixcon.com